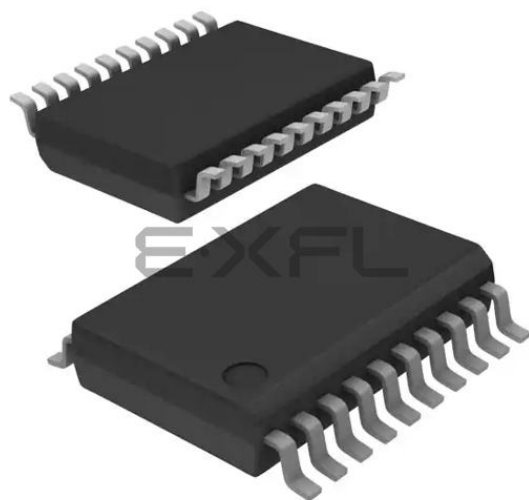




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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Obsolete
Core Processor	Z8
Core Size	8-Bit
Speed	8MHz
Connectivity	-
Peripherals	HLVD, POR, WDT
Number of I/O	16
Program Memory Size	32KB (32K x 8)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	237 x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 3.6V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	20-SSOP (0.209", 5.30mm Width)
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/zilog/zgp323lsh2032c00tr



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Development Features

Table 1 lists the features of ZiLOG®'s Z8 GP™ OTP MCU Family family members.

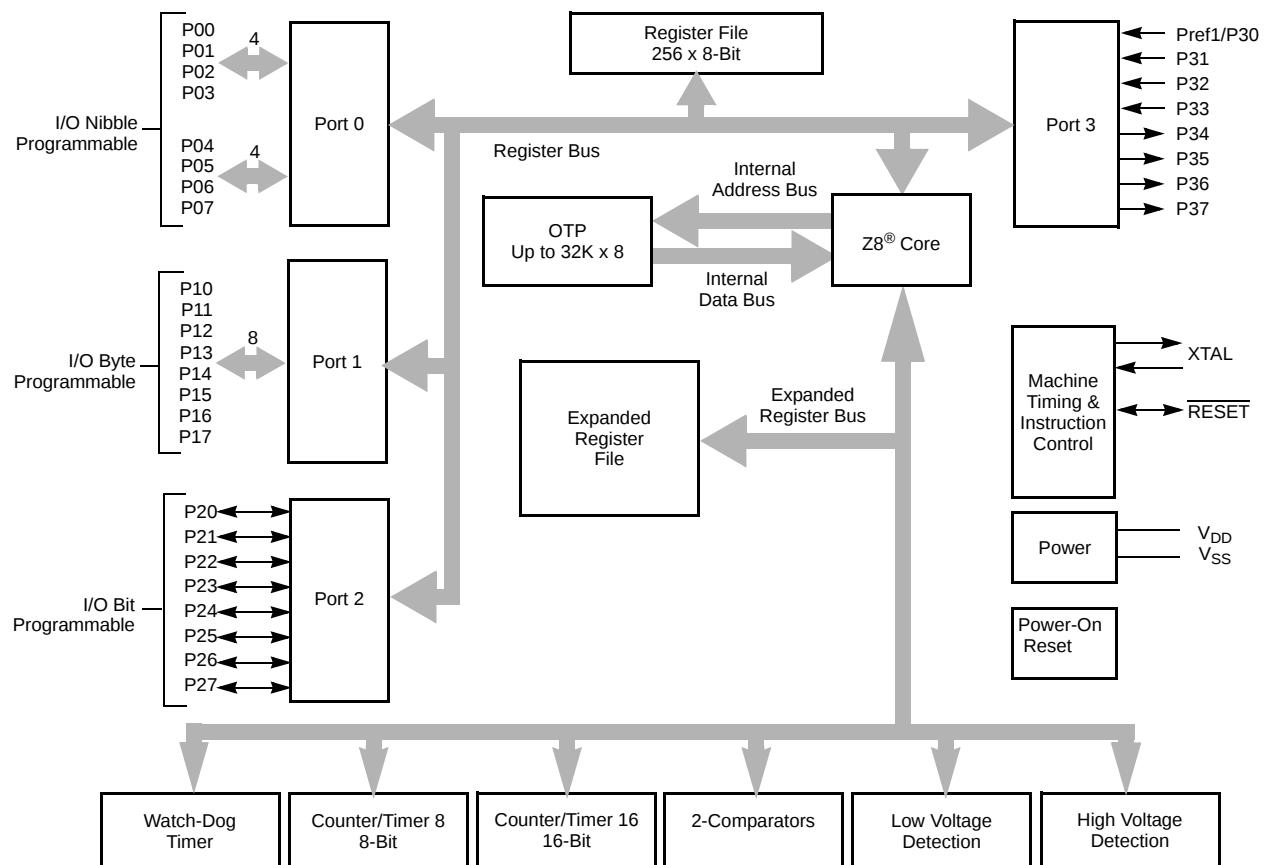
Table 1. Features

Device	OTP (KB)	RAM (Bytes)	I/O Lines	Voltage Range
ZGP323L OTP MCU Family	4, 8, 16, 32	237	32, 24 or 16	2.0V–3.6V

- Low power consumption—6mW (typical)
- T = Temperature
S = Standard 0° to +70°C
E = Extended -40° to +105°C
A = Automotive -40° to +125°C
- Three standby modes:
 - STOP—2μA (typical)
 - HALT—0.8mA (typical)
 - Low voltage reset
- Special architecture to automate both generation and reception of complex pulses or signals:
 - One programmable 8-bit counter/timer with two capture registers and two load registers
 - One programmable 16-bit counter/timer with one 16-bit capture register pair and one 16-bit load register pair
 - Programmable input glitch filter for pulse reception
- Six priority interrupts
 - Three external
 - Two assigned to counter/timers
 - One low-voltage detection interrupt
- Low voltage detection and high voltage detection flags
- Programmable Watch-Dog Timer/Power-On Reset (WDT/POR) circuits
- Two independent comparators with programmable interrupt polarity
- Programmable EPROM options
 - Port 0: 0–3 pull-up transistors
 - Port 0: 4–7 pull-up transistors

Table 2. Power Connections

Connection	Circuit	Device
Power	V _{CC}	V _{DD}
Ground	GND	V _{SS}



Note: Refer to the specific package for available pins.

Figure 1. Functional Block Diagram

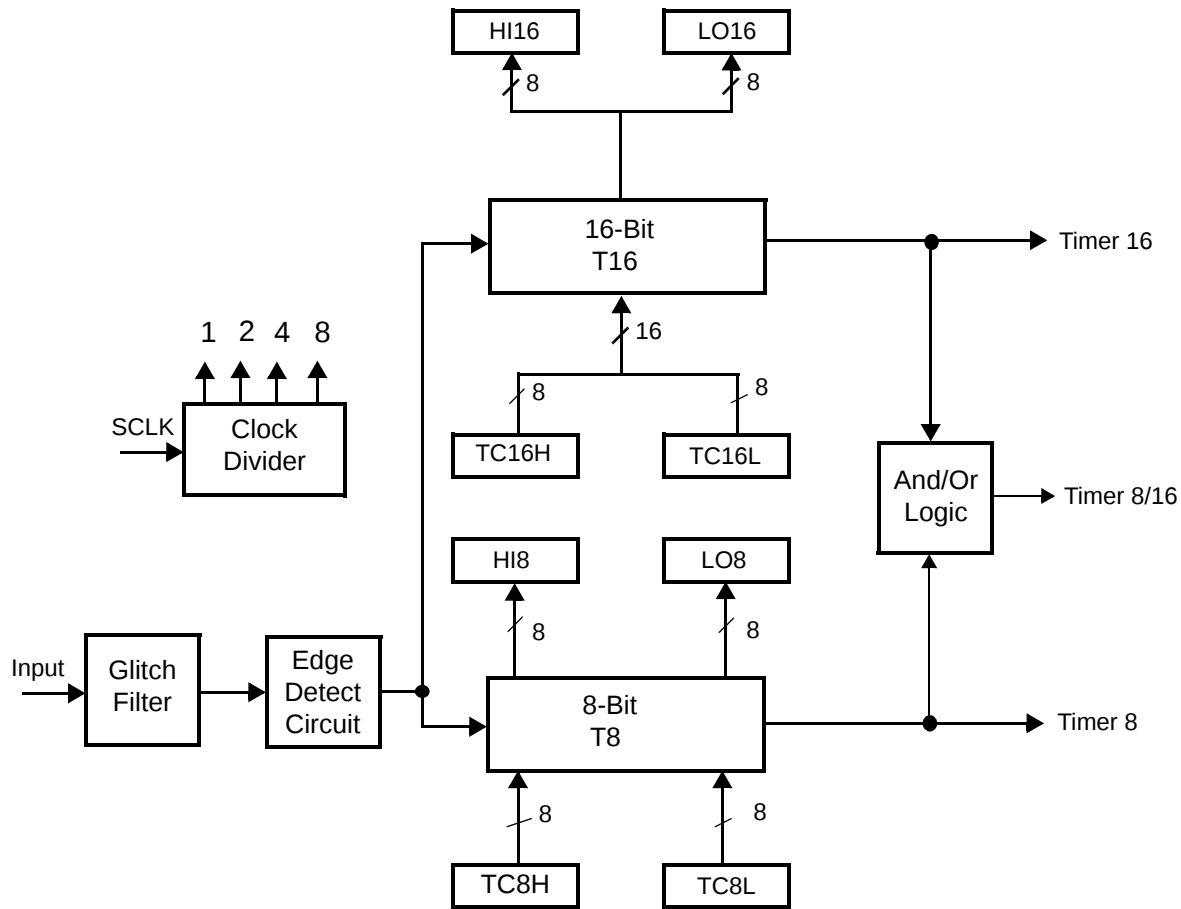


Figure 2. Counter/Timers Diagram

Pin Description

The pin configuration for the 20-pin PDIP/SOIC/SSOP is illustrated in Figure 3 and described in Table 3. The pin configuration for the 28-pin PDIP/SOIC/SSOP are depicted in Figure 4 and described in Table 4. The pin configurations for the 40-pin PDIP and 48-pin SSOP versions are illustrated in Figure 5, Figure 6, and described in Table 5.

For customer engineering code development, a UV eraseable windowed cerdip packaging is offered in 20-pin, 28-pin, and 40-pin configurations. ZILOG does not recommend nor guarantee these packages for use in production.

Absolute Maximum Ratings

Stresses greater than those listed in Table 7 might cause permanent damage to the device. This rating is a stress rating only. Functional operation of the device at any condition above those indicated in the operational sections of these specifications is not implied. Exposure to absolute maximum rating conditions for an extended period might affect device reliability.

Table 6. Absolute Maximum Ratings

Parameter	Minimum	Maximum	Units	Notes
Ambient temperature under bias	0	+70	C	
Storage temperature	−65	+150	C	
Voltage on any pin with respect to V_{SS}	−0.3	+5.5	V	1
Voltage on V_{DD} pin with respect to V_{SS}	−0.3	+3.6	V	
Maximum current on input and/or inactive output pin	−5	+5	μ A	
Maximum output current from active output pin	−25	+25	mA	
Maximum current into V_{DD} or out of V_{SS}		75	mA	

Notes:
This voltage applies to all pins except the following: V_{DD} , P32, P33 and $\overline{\text{RESET}}$.

Standard Test Conditions

The characteristics listed in this product specification apply for standard test conditions as noted. All voltages are referenced to GND. Positive current flows into the referenced pin (see Figure 7).

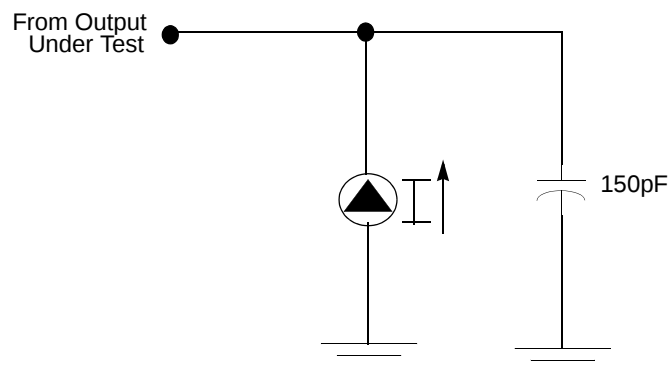


Figure 7. Test Load Diagram

Pin Functions

XTAL1 Crystal 1 (Time-Based Input)

This pin connects a parallel-resonant crystal or ceramic resonator to the on-chip oscillator input. Additionally, an optional external single-phase clock can be coded to the on-chip oscillator input.

XTAL2 Crystal 2 (Time-Based Output)

This pin connects a parallel-resonant crystal or ceramic resonator to the on-chip oscillator output.

Port 0 (P07–P00)

Port 0 is an 8-bit, bidirectional, CMOS-compatible port. These eight I/O lines are configured under software control as a nibble I/O port. The output drivers are push-pull or open-drain controlled by bit D2 in the PCON register.

If one or both nibbles are needed for I/O operation, they must be configured by writing to the Port 0 mode register. After a hardware reset, Port 0 is configured as an input port.

An optional pull-up transistor is available as a mask option on all Port 0 bits with nibble select.

- **Notes:** Internal pull-ups are disabled on any given pin or group of port pins when programmed into output mode.

The Port 0 direction is reset to be input following an SMR.

Table 13. CTR1(0D)01H T8 and T16 Common Functions (Continued)

Field	Bit Position		Value	Description
Transmit_Submode/ Glitch_Filter	----32--	R/W		Transmit Mode
			00*	Normal Operation
			01	Ping-Pong Mode
			10	T16_Out = 0
			11	T16_Out = 1
				Demodulation Mode
			00*	No Filter
			01	4 SCLK Cycle
			10	8 SCLK Cycle
			11	Reserved
Initial_T8_Out/ Rising Edge	-----1-	R/W	0*	Transmit Mode
			1	T8_OUT is 0 Initially
		R	0*	T8_OUT is 1 Initially
			1	Demodulation Mode
		W	0	No Rising Edge
			1	Rising Edge Detected
			0	No Effect
			1	Reset Flag to 0
Initial_T16_Out/ Falling_Edge	-----0	R/W	0*	Transmit Mode
			1	T16_OUT is 0 Initially
		R	0*	T16_OUT is 1 Initially
			1	Demodulation Mode
		W	0	No Falling Edge
			1	Falling Edge Detected
			0	No Effect
			1	Reset Flag to 0

Note:

*Default at Power-On Reset.

**Default at Power-On Reset. Not reset with Stop Mode recovery.

Mode

If the result is 0, the counter/timers are in TRANSMIT mode; otherwise, they are in DEMODULATION mode.

P36_Out/Demodulator_Input

In TRANSMIT Mode, this bit defines whether P36 is used as a normal output pin or the combined output of T8 and T16.

In DEMODULATION Mode, this bit defines whether the input signal to the Counter/Timers is from P20 or P31.

If the input signal is from Port 31, a capture event may also generate an IRQ2 interrupt. To prevent generating an IRQ2, either disable the IRQ2 interrupt by clearing its IMR bit D2 or use P20 as the input.

In Demodulation Mode, when set to 0, T16 captures and reloads on detection of all the edges. When set to 1, T16 captures and detects on the first edge but ignores the subsequent edges. For details, see the description of T16 Demodulation Mode on page 45.

Time_Out

This bit is set when T16 times out (terminal count reached). To reset the bit, write a 1 to this location.

T16_Clock

This bit defines the frequency of the input signal to Counter/Timer16.

Capture_INT_Mask

This bit is set to allow an interrupt when data is captured into LO16 and HI16.

Counter_INT_Mask

Set this bit to allow an interrupt when T16 times out.

P35_Out

This bit defines whether P35 is used as a normal output pin or T16 output.

CTR3 T8/T16 Control Register—CTR3(D)03H

Table 15 lists and briefly describes the fields for this register. This register allows the T₈ and T₁₆ counters to be synchronized.

Table 15. CTR3 (D)03H: T8/T16 Control Register

Field	Bit Position		Value	Description
T ₁₆ Enable	7-----	R	0*	Counter Disabled
		R	1	Counter Enabled
		W	0	Stop Counter
		W	1	Enable Counter
T ₈ Enable	-6-----	R	0*	Counter Disabled
		R	1	Counter Enabled
		W	0	Stop Counter
		W	1	Enable Counter
Sync Mode	--5-----	R/W	0**	Disable Sync Mode
			1	Enable Sync Mode

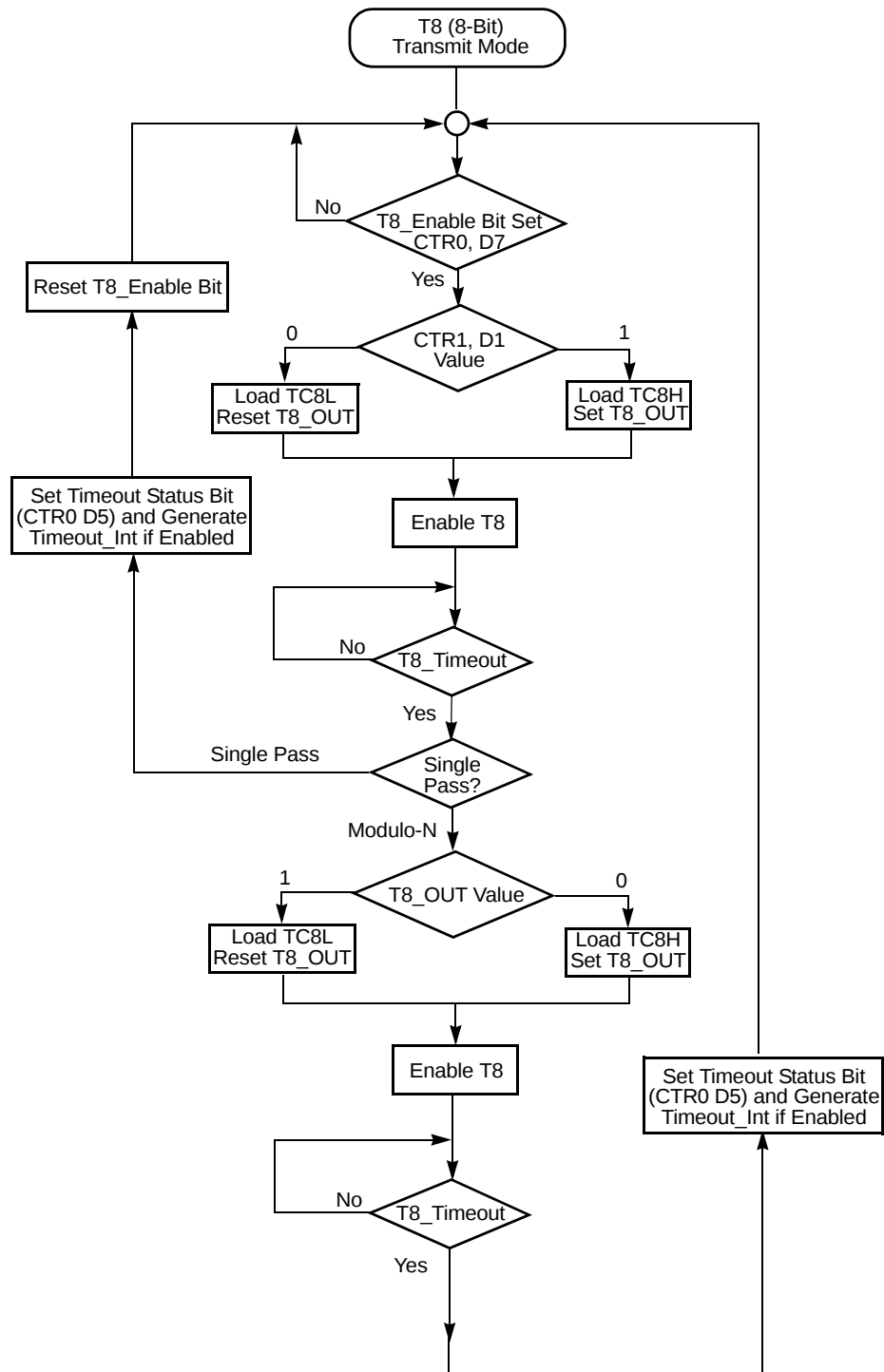


Figure 19. Transmit Mode Flowchart

If D6 of CTR2 Is 1

T16 ignores the subsequent edges in the input signal and continues counting down. A timeout of T8 causes T16 to capture its current value and generate an interrupt if enabled (CTR2, D2). In this case, T16 does not reload and continues counting. If the D6 bit of CTR2 is toggled (by writing a 0 then a 1 to it), T16 captures and reloads on the next edge (rising, falling, or both depending on CTR1, D5; D4), continuing to ignore subsequent edges.

This T16 mode generally measures mark time, the length of an active carrier signal burst.

If T16 reaches 0, T16 continues counting from `FFFFh`. Meanwhile, a status bit (CTR2 D5) is set, and an interrupt timeout can be generated if enabled (CTR2 D1).

Ping-Pong Mode

This operation mode is only valid in TRANSMIT Mode. T8 and T16 must be programmed in Single-Pass mode (CTR0, D6; CTR2, D6), and Ping-Pong mode must be programmed in CTR1, D3; D2. The user can begin the operation by enabling either T8 or T16 (CTR0, D7 or CTR2, D7). For example, if T8 is enabled, T8_OUT is set to this initial value (CTR1, D1). According to T8_OUT's level, TC8H or TC8L is loaded into T8. After the terminal count is reached, T8 is disabled, and T16 is enabled. T16_OUT then switches to its initial value (CTR1, D0), data from TC16H and TC16L is loaded, and T16 starts to count. After T16 reaches the terminal count, it stops, T8 is enabled again, repeating the entire cycle. Interrupts can be allowed when T8 or T16 reaches terminal control (CTR0, D1; CTR2, D1). To stop the ping-pong operation, write 00 to bits D3 and D2 of CTR1. See Figure 28.

- **Note:** Enabling ping-pong operation while the counter/timers are running might cause intermittent counter/timer function. Disable the counter/timers and reset the status flags before instituting this operation.

Power-On Reset

A timer circuit clocked by a dedicated on-board RC-oscillator is used for the Power-On Reset (POR) timer function. The POR time allows V_{DD} and the oscillator circuit to stabilize before instruction execution begins.

The POR timer circuit is a one-shot timer triggered by one of three conditions:

- Power Fail to Power OK status, including Waking up from V_{BO} Standby
- Stop-Mode Recovery (if D5 of SMR = 1)
- WDT Timeout

The POR timer is 2.5 ms minimum. Bit 5 of the Stop-Mode Register determines whether the POR timer is bypassed after Stop-Mode Recovery (typical for external clock).

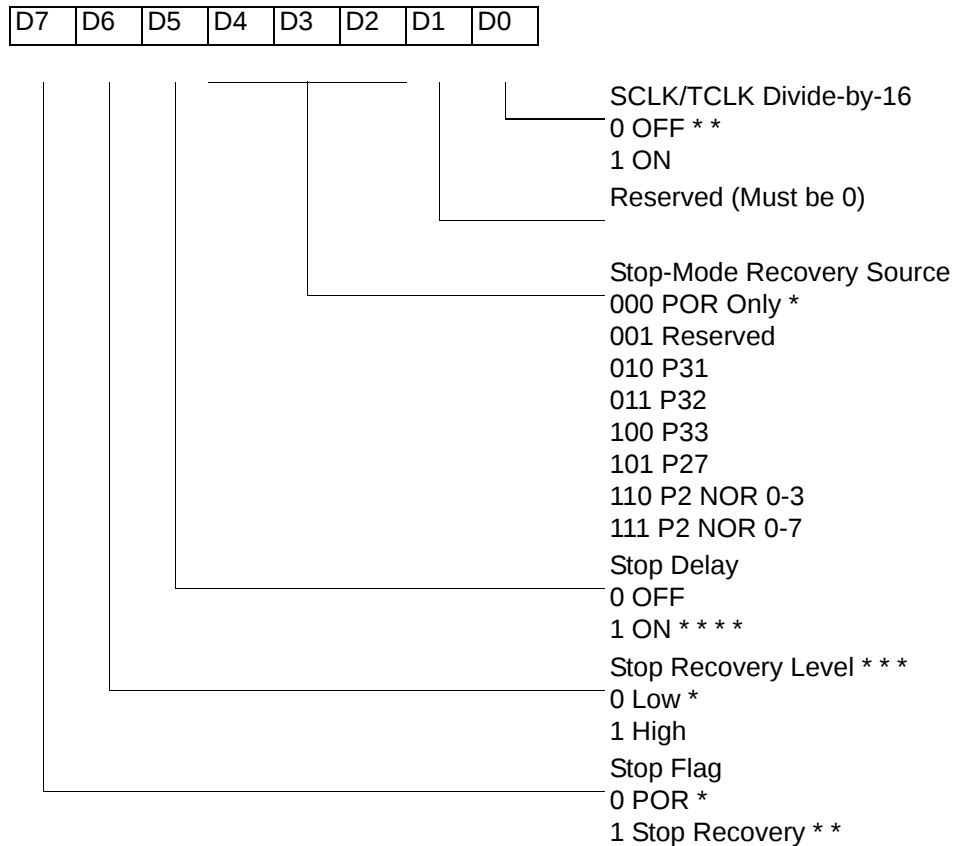
HALT Mode

This instruction turns off the internal CPU clock, but not the XTAL oscillation. The counter/timers and external interrupts IRQ0, IRQ1, IRQ2, IRQ3, IRQ4, and IRQ5 remain active. The devices are recovered by interrupts, either externally or internally generated. An interrupt request must be executed (enabled) to exit HALT Mode. After the interrupt service routine, the program continues from the instruction after HALT Mode.

STOP Mode

This instruction turns off the internal clock and external crystal oscillation, reducing the standby current to 10 μ A or less. STOP Mode is terminated only by a reset, such as WDT timeout, POR, SMR or external reset. This condition causes the processor to restart the application program at address 000CH. To enter STOP (or HALT) mode, first flush the instruction pipeline to avoid suspending execution in mid-instruction. Execute a NOP (Opcode = FFH) immediately before the appropriate sleep instruction, as follows:

SMR(0F)0BH



* Default after Power On Reset or Watch-Dog Reset

** Set after STOP Mode Recovery

*** At the XOR gate input

**** Default setting after reset. Must be 1 if using a crystal or resonator clock source.

Figure 33. STOP Mode Recovery Register

SCLK/TCLK Divide-by-16 Select (D0)

D0 of the SMR controls a divide-by-16 prescaler of SCLK/TCLK (Figure 34). This control selectively reduces device power consumption during normal processor execution (SCLK control) and/or Halt Mode (where TCLK sources interrupt logic). After Stop Mode Recovery, this bit is set to a 0.

Low-Voltage Detection Register—LVD(D)0Ch

- **Note:** Voltage detection does not work at Stop mode. It must be disabled during Stop mode in order to reduce current.

Field	Bit Position	Description		
LVD	76543---	Reserved No Effect		
	----2--	R	1 0*	HVD flag set HVD flag reset
	-----1-	R	1 0*	LVD flag set LVD flag reset
	-----0	R/W	1 0*	Enable VD Disable VD
*Default after POR				

- **Note:** Do not modify register P01M while checking a low-voltage condition. Switching noise of both ports 0 and 1 together might trigger the LVD flag.

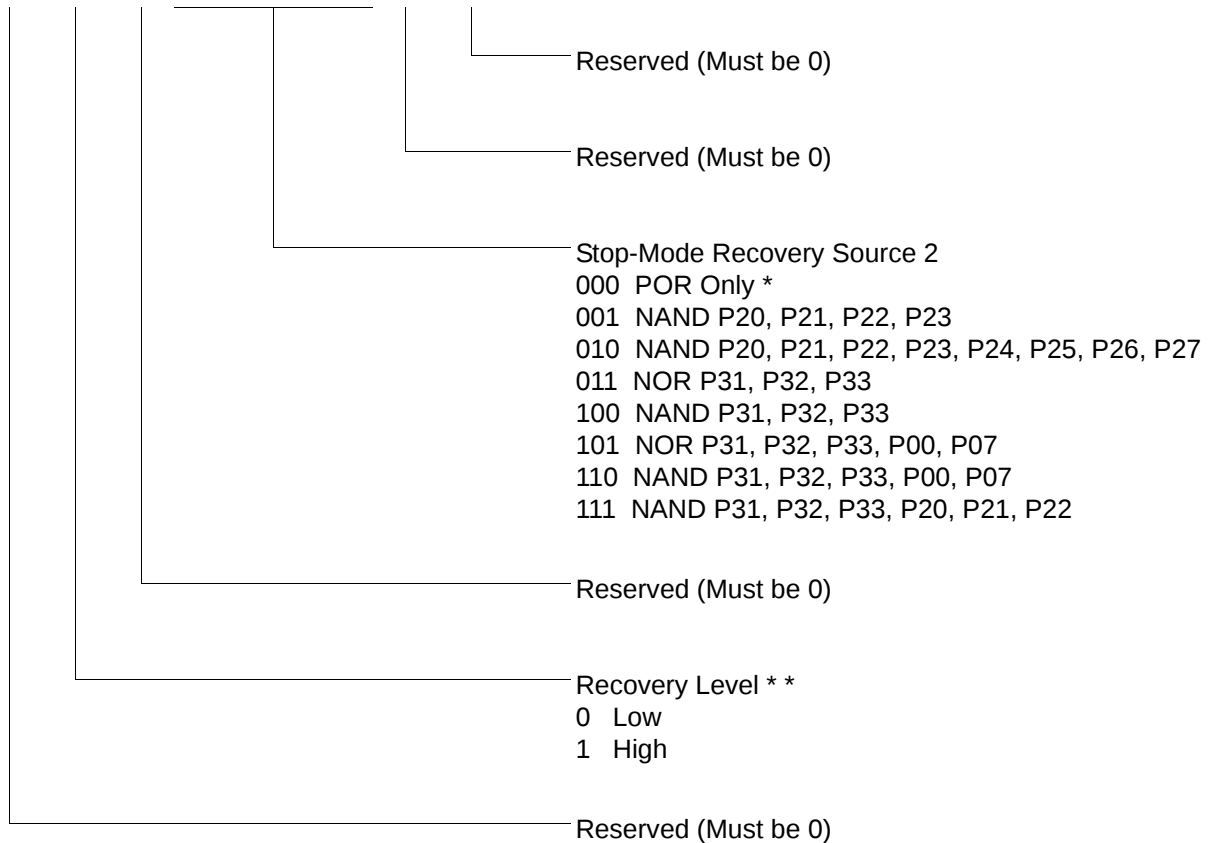
Voltage Detection and Flags

The Voltage Detection register (LVD, register 0CH at the expanded register bank 0Dh) offers an option of monitoring the V_{CC} voltage. The Voltage Detection is enabled when bit 0 of LVD register is set. Once Voltage Detection is enabled, the the V_{CC} level is monitored in real time. The flags in the LVD register valid 20uS after Voltage Detection is enabled. The HVD flag (bit 2 of the LVD register) is set only if V_{CC} is higher than V_{HVD} . The LVD flag (bit 1 of the LVD register) is set only if V_{CC} is lower than the V_{LVD} . When Voltage Detection is enabled, the LVD flag also triggers IRQ5. The IRQ bit 5 latches the low voltage condition until it is cleared by instructions or reset. The IRQ5 interrupt is served if it is enabled in the IMR register. Otherwise, bit 5 of IRQ register is latched as a flag only.

- **Notes:** If it is necessary to receive an LVD interrupt upon power-up at an operating voltage lower than the low battery detect threshold, enable interrupts using the Enable Interrupt instruction (EI) prior to enabling the voltage detection.

SMR2(0F)0DH

D7	D6	D5	D4	D3	D2	D1	D0
----	----	----	----	----	----	----	----



Note: If used in conjunction with SMR, either of the two specified events causes a Stop-Mode Recovery.

* Default setting after reset

* * At the XOR gate input

Figure 46. Stop Mode Recovery Register 2 ((0F)0DH:D2–D4, D6 Write Only)

R250 IRQ(FAH)

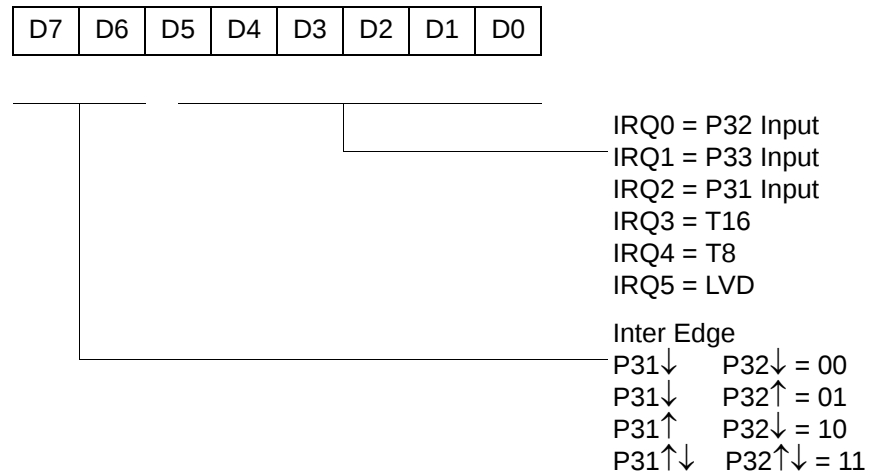
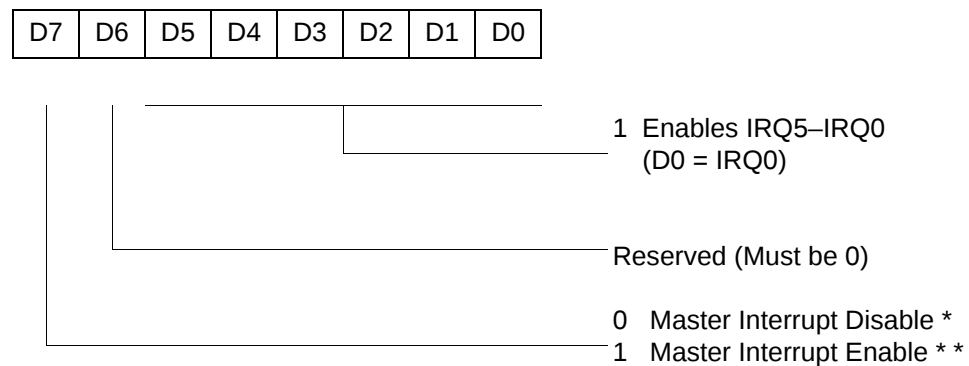


Figure 52. Interrupt Request Register (FAH: Read/Write)

R251 IMR(FBH)



* Default setting after reset

** Only by using EI, DI instruction; DI is required before changing the IMR register

Figure 53. Interrupt Mask Register (FBH: Read/Write)

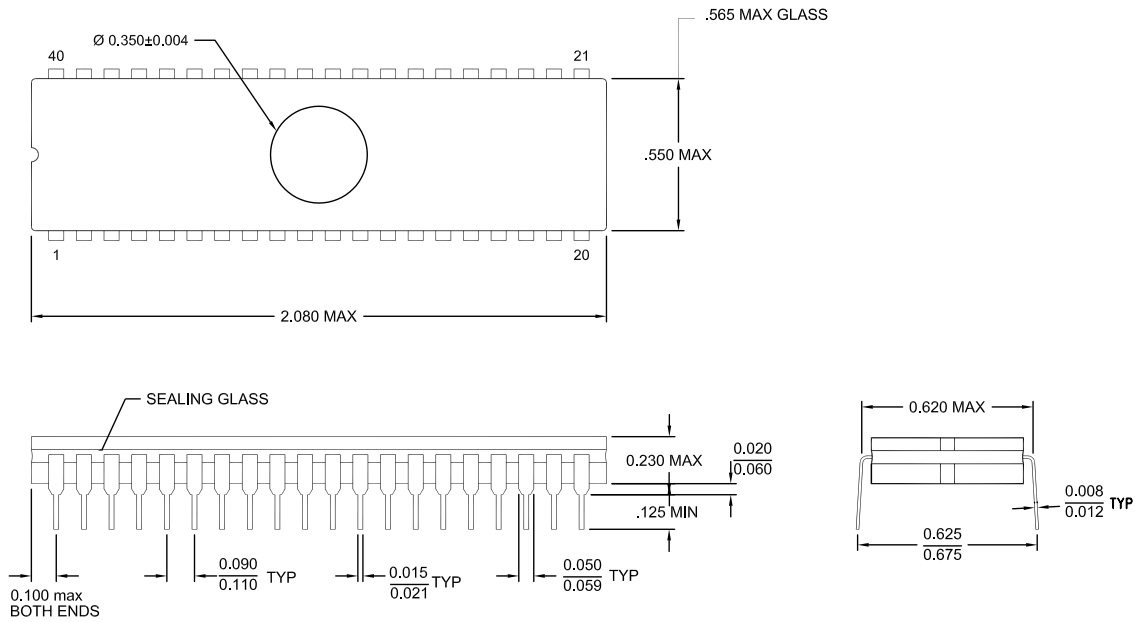
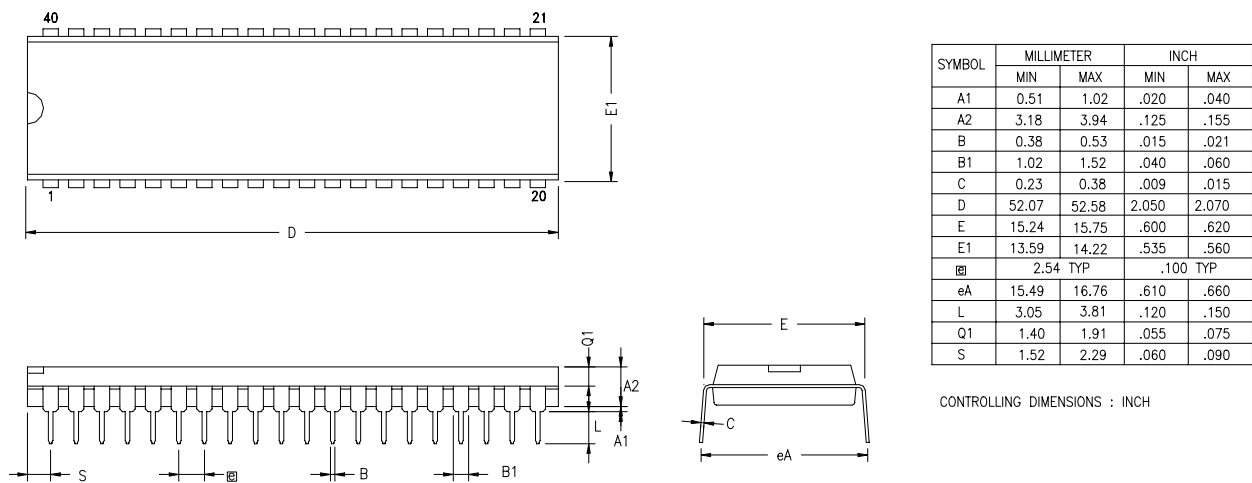


Figure 66. 40-Pin CDIP Package



CONTROLLING DIMENSIONS : INCH

Figure 67. 40-Pin PDIP Package Diagram

Ordering Information

32KB Standard Temperature: 0° to +70°C			
Part Number	Description	Part Number	Description
ZGP323LSH4832C	48-pin SSOP 32K OTP	ZGP323LSS2832C	28-pin SOIC 32K OTP
ZGP323LSP4032C	40-pin PDIP 32K OTP	ZGP323LSH2032C	20-pin SSOP 32K OTP
ZGP323LSH2832C	28-pin SSOP 32K OTP	ZGP323LSP2032C	20-pin PDIP 32K OTP
ZGP323LSP2832C	28-pin PDIP 32K OTP	ZGP323LSS2032C	20-pin SOIC 32K OTP
ZGP323LSK2032E	20-pin CDIP 32K OTP	ZGP323LSK4032E	40-pin CDIP 32K OTP
		ZGP323LSK2832E	28-pin CDIP 32K OTP
32KB Extended Temperature: -40° to +105°C			
Part Number	Description	Part Number	Description
ZGP323LEH4832C	48-pin SSOP 32K OTP	ZGP323LES2832C	28-pin SOIC 32K OTP
ZGP323LEP4032C	40-pin PDIP 32K OTP	ZGP323LEH2032C	20-pin SSOP 32K OTP
ZGP323LEH2832C	28-pin SSOP 32K OTP	ZGP323LEP2032C	20-pin PDIP 32K OTP
ZGP323LEP2832C	28-pin PDIP 32K OTP	ZGP323LES2032C	20-pin SOIC 32K OTP
32KB Automotive Temperature: -40° to +125°C			
Part Number	Description	Part Number	Description
ZGP323LAH4832C	48-pin SSOP 32K OTP	ZGP323LAS2832C	28-pin SOIC 32K OTP
ZGP323LAP4032C	40-pin PDIP 32K OTP	ZGP323LAH2032C	20-pin SSOP 32K OTP
ZGP323LAH2832C	28-pin SSOP 32K OTP	ZGP323LAP2032C	20-pin PDIP 32K OTP
ZGP323LAP2832C	28-pin PDIP 32K OTP	ZGP323LAS2032C	20-pin SOIC 32K OTP
Note: Replace C with G for Lead-Free Packaging			



16KB Standard Temperature: 0° to +70°C

Part Number	Description	Part Number	Description
ZGP323LSH4816C	48-pin SSOP 16K OTP	ZGP323LSS2816C	28-pin SOIC 16K OTP
ZGP323LSP4016C	40-pin PDIP 16K OTP	ZGP323LSH2016C	20-pin SSOP 16K OTP
ZGP323LSH2816C	28-pin SSOP 16K OTP	ZGP323LSP2016C	20-pin PDIP 16K OTP
ZGP323LSP2816C	28-pin PDIP 16K OTP	ZGP323LSS2016C	20-pin SOIC 16K OTP

16KB Extended Temperature: -40° to +105°C

Part Number	Description	Part Number	Description
ZGP323LEH4816C	48-pin SSOP 16K OTP	ZGP323LES2816C	28-pin SOIC 16K OTP
ZGP323LEP4016C	40-pin PDIP 16K OTP	ZGP323LES2016C	20-pin SOIC 16K OTP
ZGP323LEH2816C	28-pin SSOP 16K OTP	ZGP323LEH2016C	20-pin SSOP 16K OTP
ZGP323LEP2816C	28-pin PDIP 16K OTP	ZGP323LEP2016C	20-pin PDIP 16K OTP

16KB Automotive Temperature: -40° to +125°C

Part Number	Description	Part Number	Description
ZGP323LAH4816C	48-pin SSOP 16K OTP	ZGP323LAS2816C	28-pin SOIC 16K OTP
ZGP323LAP4016C	40-pin PDIP 16K OTP	ZGP323LAH2016C	20-pin SSOP 16K OTP
ZGP323LAH2816C	28-pin SSOP 16K OTP	ZGP323LAP2016C	20-pin PDIP 16K OTP
ZGP323LAP2816C	28-pin PDIP 16K OTP	ZGP323LAS2016C	20-pin SOIC 16K OTP

Note: Replace C with G for Lead-Free Packaging



8KB Standard Temperature: 0° to +70°C

Part Number	Description	Part Number	Description
ZGP323LSH4808C	48-pin SSOP 8K OTP	ZGP323LSS2808C	28-pin SOIC 8K OTP
ZGP323LSP4008C	40-pin PDIP 8K OTP	ZGP323LSH2008C	20-pin SSOP 8K OTP
ZGP323LSH2808C	28-pin SSOP 8K OTP	ZGP323LSP2008C	20-pin PDIP 8K OTP
ZGP323LSP2808C	28-pin PDIP 8K OTP	ZGP323LSS2008C	20-pin SOIC 8K OTP

8KB Extended Temperature: -40° to +105°C

Part Number	Description	Part Number	Description
ZGP323LEH4808C	48-pin SSOP 8K OTP	ZGP323LES2808C	28-pin SOIC 8K OTP
ZGP323LEP4008C	40-pin PDIP 8K OTP	ZGP323LEH2008C	20-pin SSOP 8K OTP
ZGP323LEH2808C	28-pin SSOP 8K OTP	ZGP323LEP2008C	20-pin PDIP 8K OTP
ZGP323LEP2808C	28-pin PDIP 8K OTP	ZGP323LES2008C	20-pin SOIC 8K OTP

8KB Automotive Temperature: -40° to +125°C

Part Number	Description	Part Number	Description
ZGP323LAH4808C	48-pin SSOP 8K OTP	ZGP323LAS2808C	28-pin SOIC 8K OTP
ZGP323LAP4008C	40-pin PDIP 8K OTP	ZGP323LAH2008C	20-pin SSOP 8K OTP
ZGP323LAH2808C	28-pin SSOP 8K OTP	ZGP323LAP2008C	20-pin PDIP 8K OTP
ZGP323LAP2808C	28-pin PDIP 8K OTP	ZGP323LAS2008C	20-pin SOIC 8K OTP

Note: Replace C with G for Lead-Free Packaging

4KB Standard Temperature: 0° to +70°C

Part Number	Description	Part Number	Description
ZGP323LSH4804C	48-pin SSOP 4K OTP	ZGP323LSS2804C	28-pin SOIC 4K OTP
ZGP323LSP4004C	40-pin PDIP 4K OTP	ZGP323LSH2004C	20-pin SSOP 4K OTP
ZGP323LSH2804C	28-pin SSOP 4K OTP	ZGP323LSP2004C	20-pin PDIP 4K OTP
ZGP323LSP2804C	28-pin PDIP 4K OTP	ZGP323LSS2004C	20-pin SOIC 4K OTP

4KB Extended Temperature: -40° to +105°C

Part Number	Description	Part Number	Description
ZGP323LEH4804C	48-pin SSOP 4K OTP	ZGP323LES2804C	28-pin SOIC 4K OTP
ZGP323LEP4004C	40-pin PDIP 4K OTP	ZGP323LEH2004C	20-pin SSOP 4K OTP
ZGP323LEH2804C	28-pin SSOP 4K OTP	ZGP323LEP2004C	20-pin PDIP 4K OTP
ZGP323LEP2804C	28-pin PDIP 4K OTP	ZGP323LES2004C	20-pin SOIC 4K OTP

4KB Automotive Temperature: -40° to +125°C

Part Number	Description	Part Number	Description
ZGP323LAH4804C	48-pin SSOP 4K OTP	ZGP323LAS2804C	28-pin SOIC 4K OTP
ZGP323LAP4004C	40-pin PDIP 4K OTP	ZGP323LAH2004C	20-pin SSOP 4K OTP
ZGP323LAH2804C	28-pin SSOP 4K OTP	ZGP323LAP2004C	20-pin PDIP 4K OTP
ZGP323LAP2804C	28-pin PDIP 4K OTP	ZGP323LAS2004C	20-pin SOIC 4K OTP

Note: Replace C with G for Lead-Free Packaging

Additional Components

Part Number	Description	Part Number	Description
ZGP323ICE01ZEM	Emulator/programmer	ZGP32300100ZPR	Programming System